



HIGH DENSITY INTEGRATED CIRCUIT PACKAGE ARCHITECTURE
PAUL N. MARSHALL
SERIAL NO: 10/662,091
REPLACEMENT SHEET
Cantor Colburn LLP, 55 Griffin Road South, Bloomfield, CT 06002

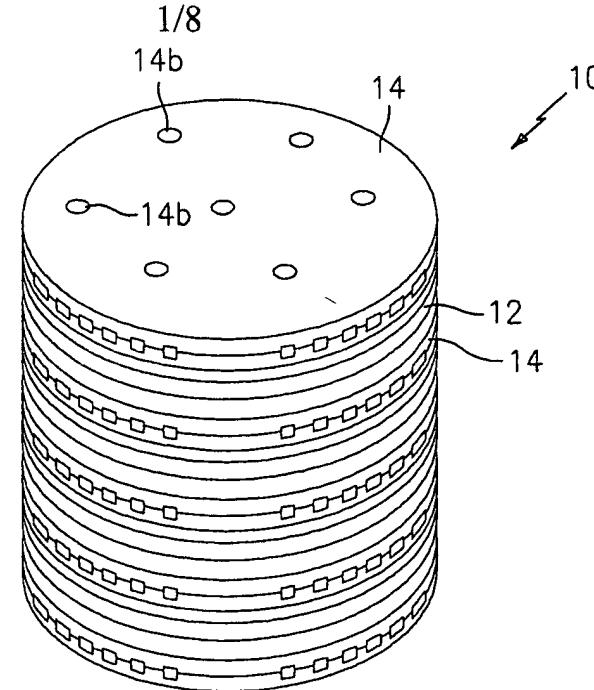


FIG. 1A

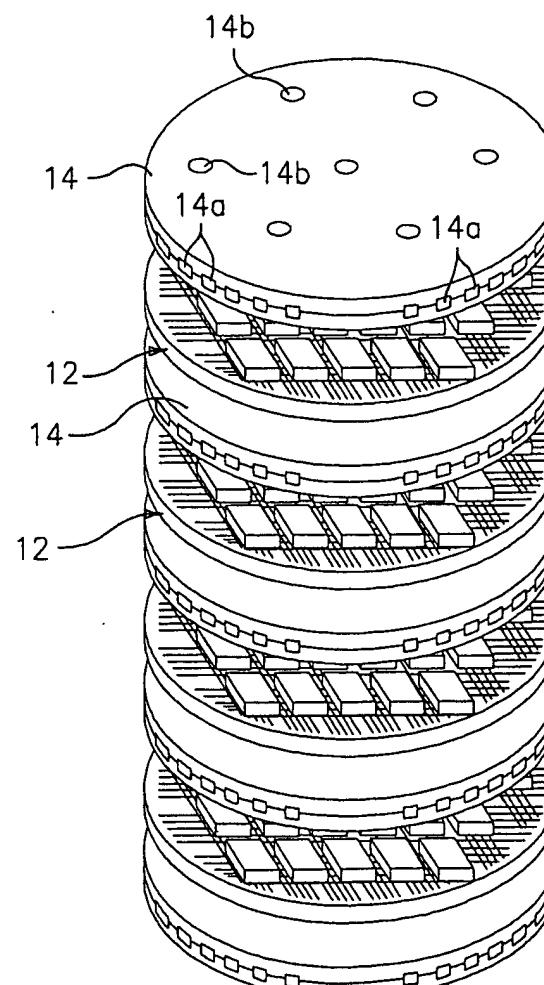


FIG. 1B

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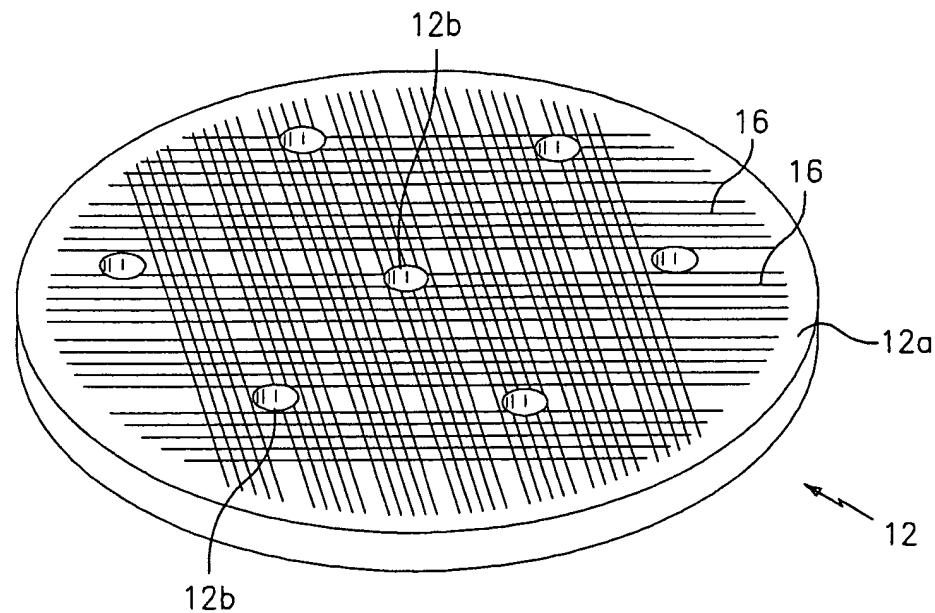


FIG. 2

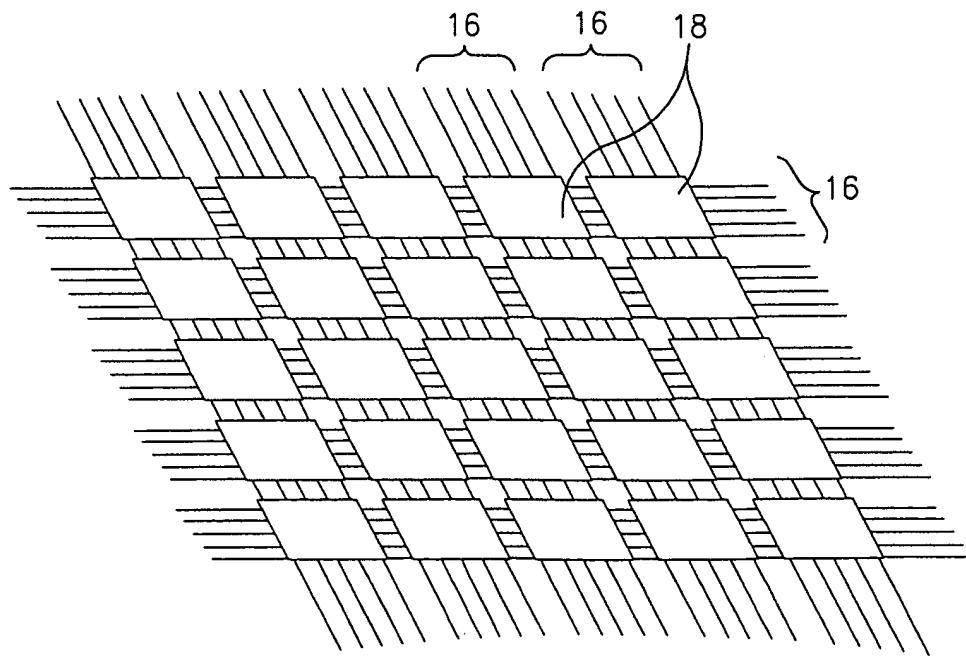


FIG. 3

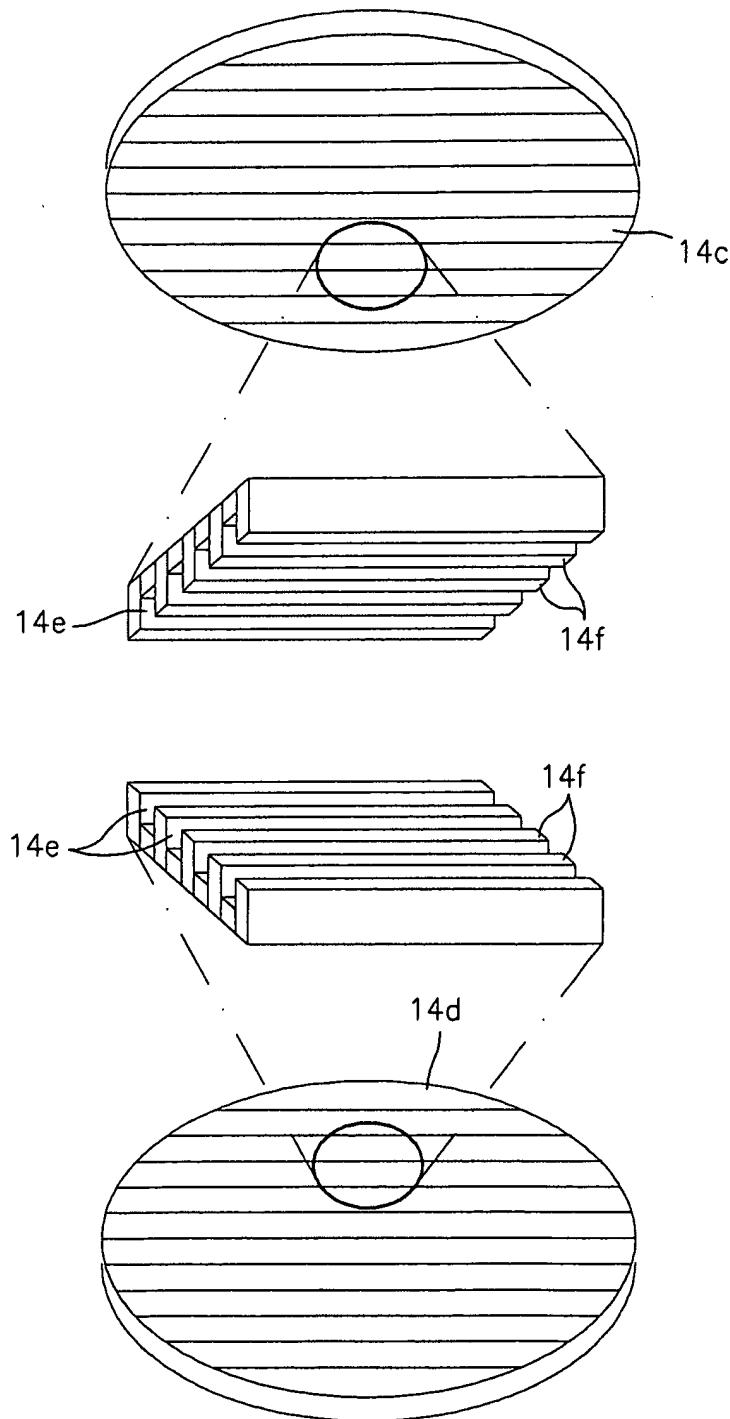


FIG. 4

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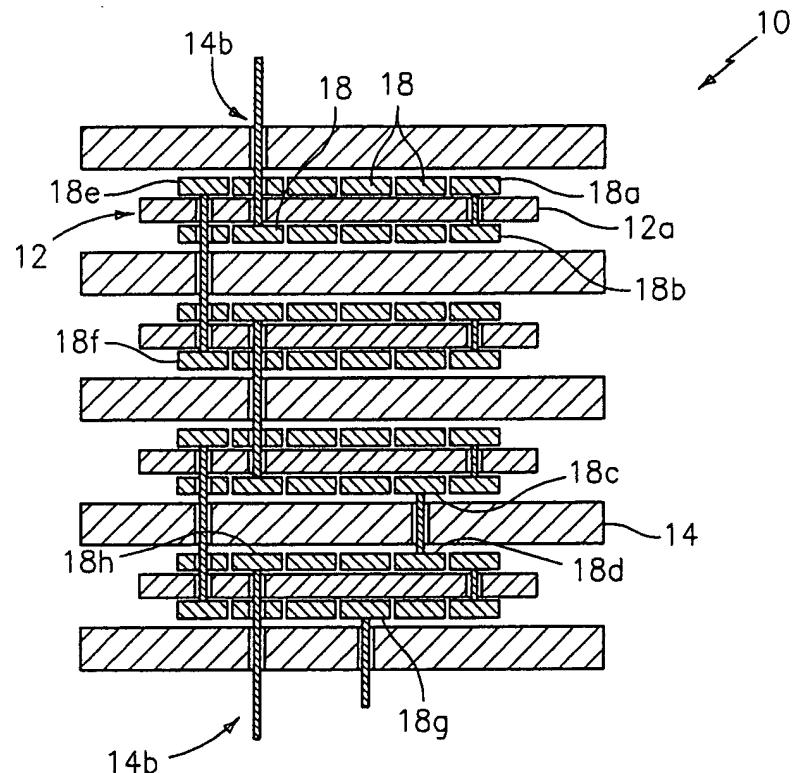


FIG. 5

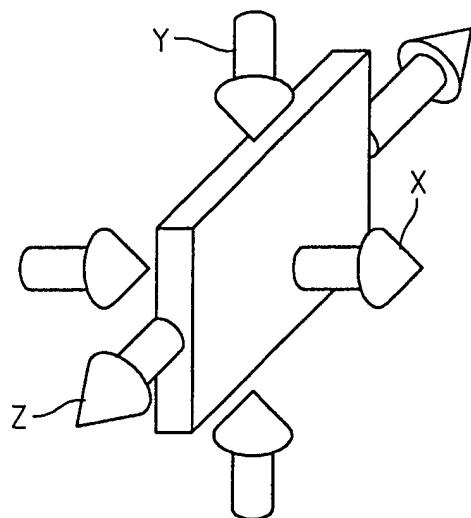


FIG. 6

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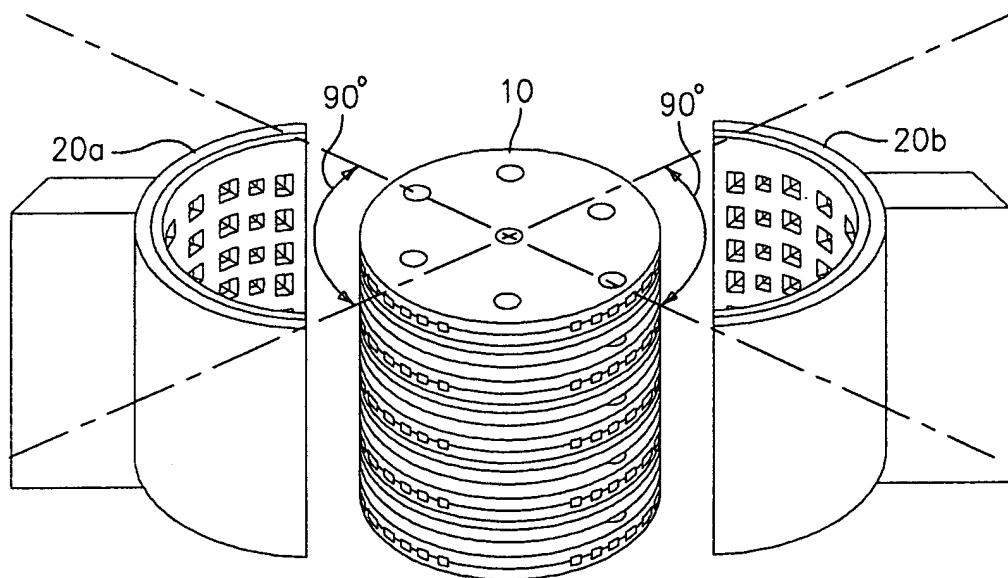


FIG. 6A

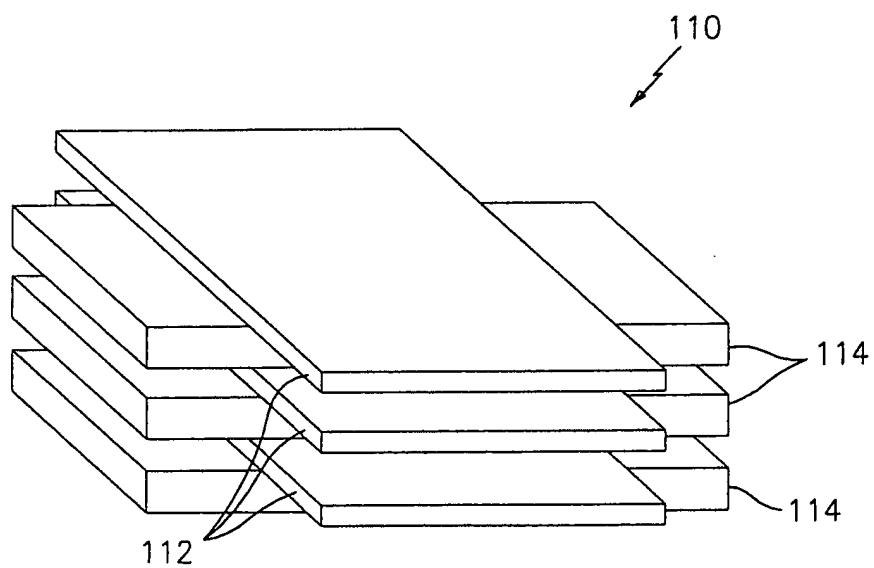


FIG. 6B

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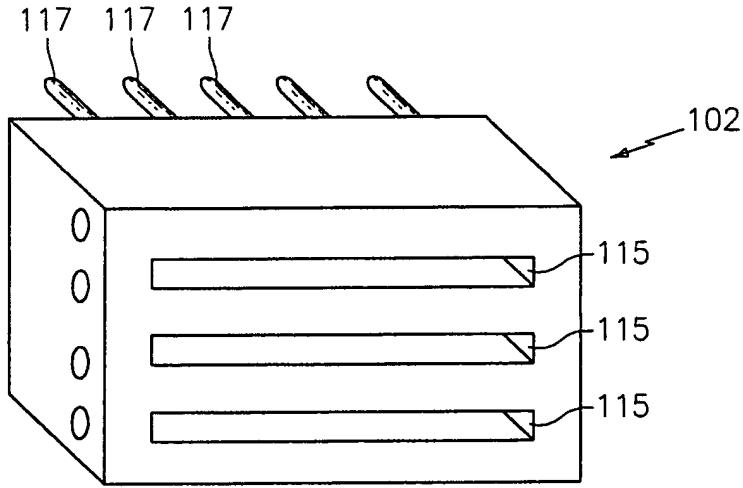


FIG. 6C

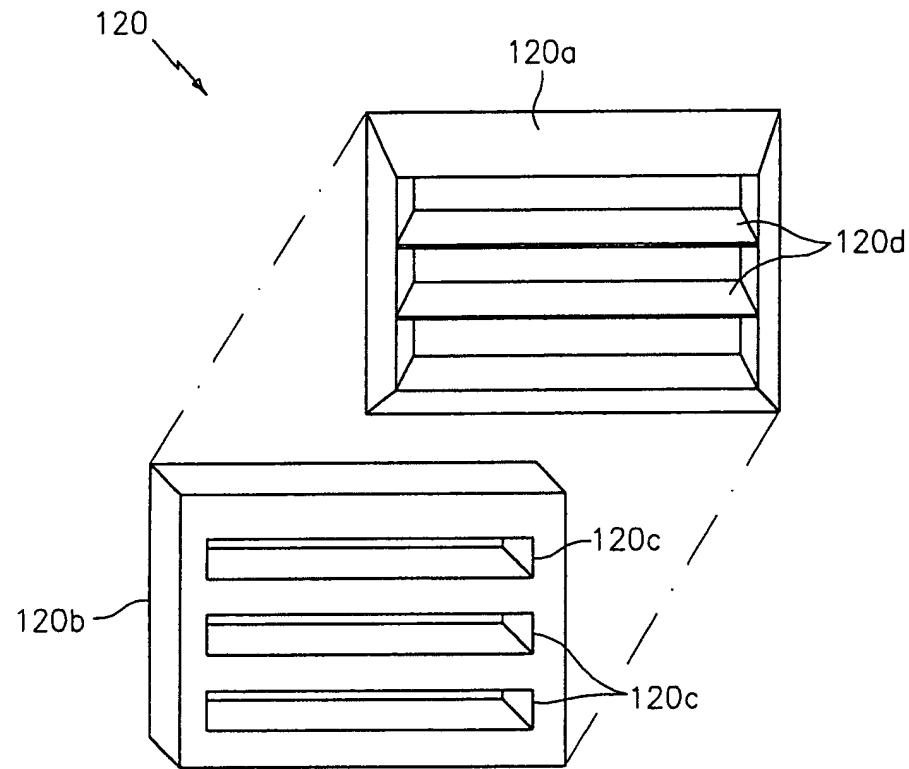


FIG. 6D

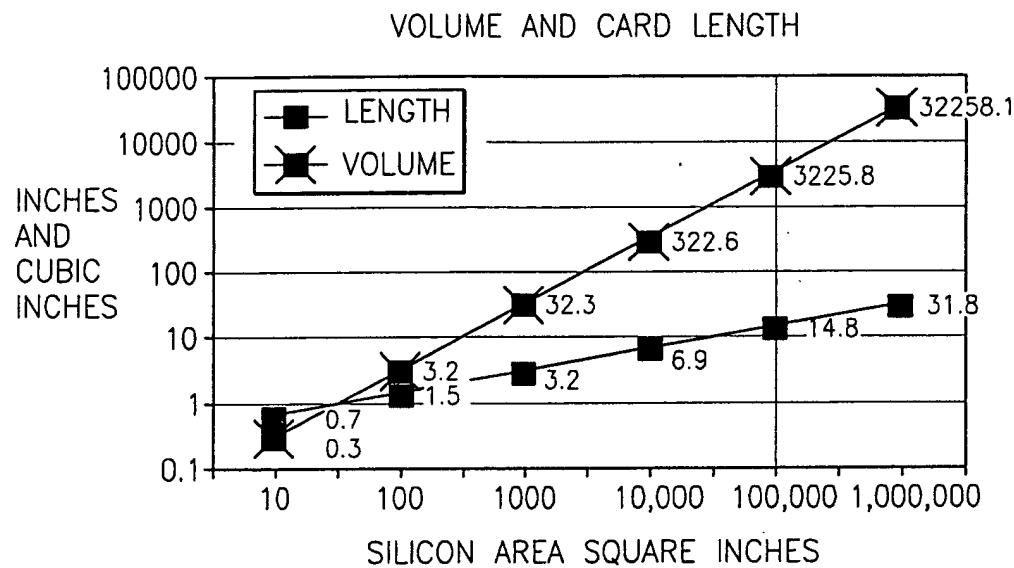


FIG. 7

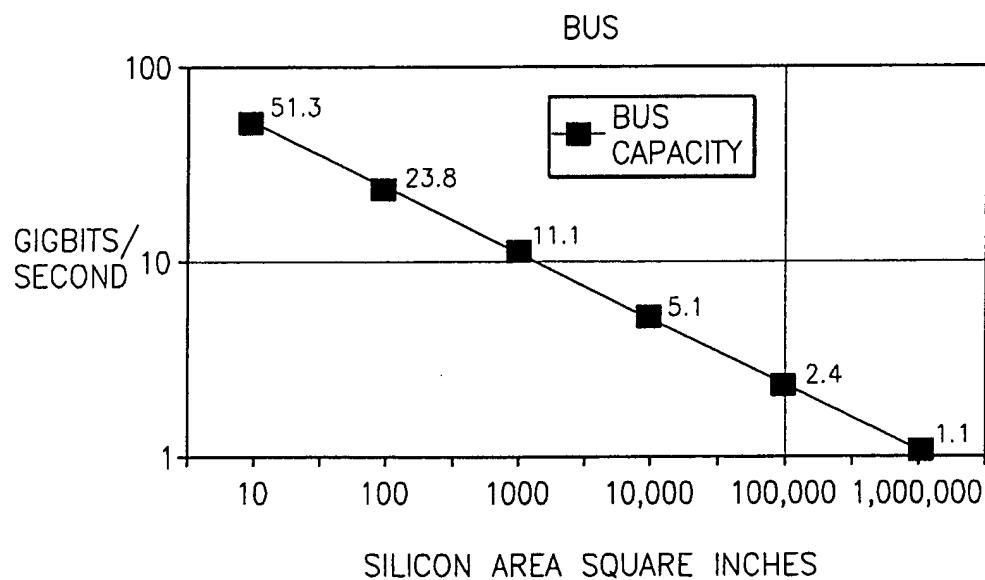


FIG. 8

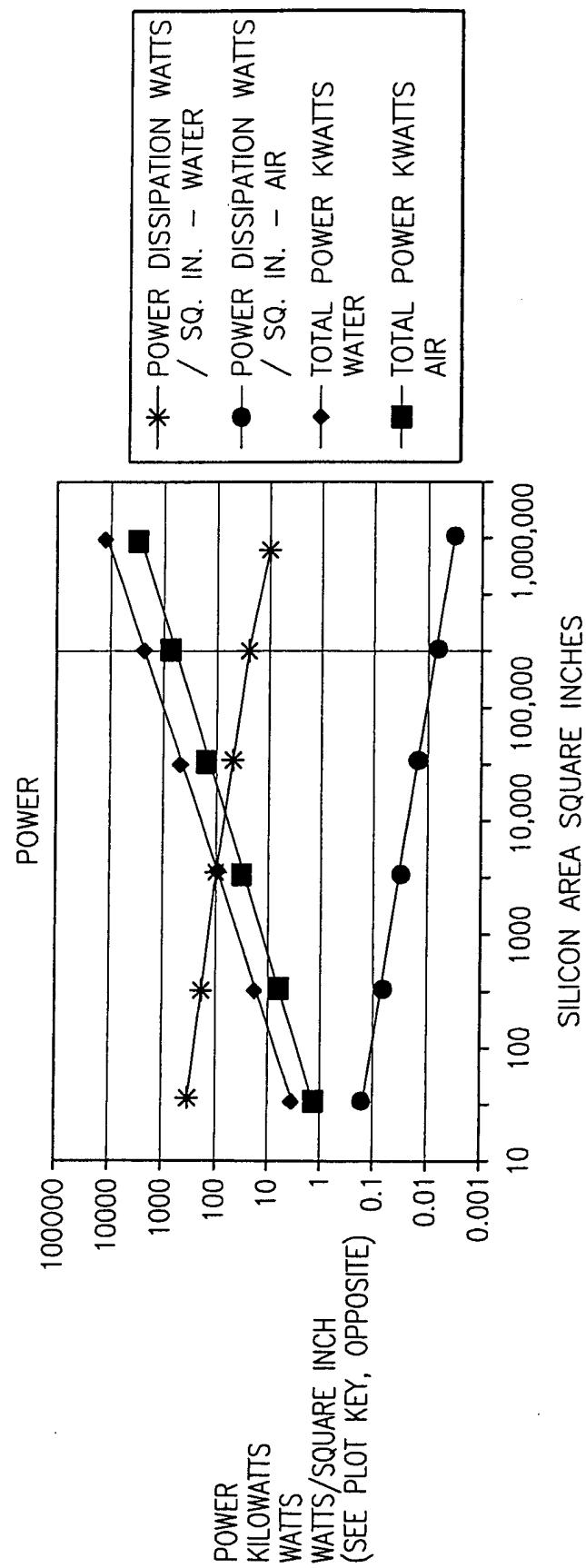


FIG. 9